AUXFN8403

Features

- Advanced Process Technology
- Ultra Low On-Resistance

International

IOR Rectifier

- 175°C Operating Temperature
- Fast Switching
- Repetitive Avalanche Allowed up to Tjmax
- Lead-Free, RoHS Compliant
- Automotive Qualified *

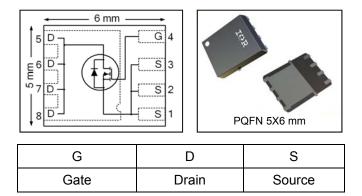
Description

Specifically designed for Automotive application s, this HEXFET[®] Power MOSFET utilizes the latest processi ng techniques to achieve extremely low on-re sistance per silicon area. Additional features of this design are a 175°C junction operating temperature, fast swithcing speed and improved repetitive avalanche rating. These fe atures combine to make this product an extremely efficient and reliable devoce for use in Automotive and wide variety of other applications.

Applications

- Electric Power Steering (EPS)
- Battery Switch
- Start/Stop Micro Hybrid
- Heavy Loads
- DC-DC Converter

V _{DSS}	40V
R _{DS(on)} typ.	2.5m Ω
max	3.3m Ω
D (Silicon Limited)	122A ①
D (Package Limited)	95A



Base Part Number	Package Type	Standard Pack		Orderable Part Number
		Form	Quantity	
AUXFN8403		Tape and Reel	4000	AUXFN8403TR
AUAFN0403	PQFN 5mm x 6mm	Tape and Reel	400	AUXFN8403TR2

Absolute Maximum Ratings

Stresses beyond those listed und er "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only; and functional operation of the device at these or any other condition beyond those indicated in the specifications is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability. The thermal resistance and power dissipation ratings are measured under board mounted and still air conditions. Ambient temperature (TA) is 25°C, unless otherwise specified.

	Parameter	Max.	Units
I _D @ T _{C (Bottom)} = 25°C	Continuous Drain Current, V _{GS} @ 10V (Silicon Limited)	122 ①	
I _D @ T _{C (Bottom)} = 100°C	Continuous Drain Current, V _{GS} @ 10V (Silicon Limited)	87①	А
I _D @ T _C = 25°C	Continuous Drain Current, V _{GS} @ 10V (Package Limited)	95	7.
I _{DM}	Pulsed Drain Current @	520	
P _D @T _{C (Bottom)} = 25°C	Power Dissipation ®	94	W
	Linear Derating Factor ®	0.63	W/°C
V _{GS}	Gate-to-Source Voltage	± 20	V
E _{AS}	Single Pulse Avalanche Energy (Thermally Limited) 3	100	mJ
E _{AS} (Tested)	Single Pulse Avalanche Energy ®	165	
I _{AR}	Avalanche Current ②	See Fig. 14, 15, 22a, 22b	Α
E _{AR}	Repetitive Avalanche Energy ②		
TJ	Operating Junction and	-55 to + 175	З°
T _{STG}	Storage Temperature Range		C

HEXFET® is a registered trademark of International Rectifier. *Qualification standards can be found at http://www.irf.com/



Thermal Resistance

Symbol	Parameter	Тур.	Max.	Units
R _{eJC} (Bottom)	Junction-to-Case		1.6	
R _{θJC} (Top)	Junction-to-Case		31	°C 1.11
$R_{ ext{ heta}JA}$	Junction-to-Ambient ®		35	°C/W
R _{θJA} (<10s)	Junction-to-Ambient ®		23	

Static Electrical Characteristics $@T_J = 25^{\circ}C$ (unless otherwise specified)

Symbol	Parameter	Min.	Тур.	Max.	Units	Conditions
V _{(BR)DSS}	Drain-to-Source Breakdown Voltage	40			V	V _{GS} = 0V, I _D = 250µA
$\Delta V_{(BR)DSS} / \Delta T_J$	Breakdown Voltage Temp. Coefficient		0.031		V/°C	Reference to 25°C, I_D = 1.0mA
R _{DS(on)}	Static Drain-to-Source On-Resistance		2.5	3.3	mΩ	V _{GS} = 10V, I _D = 50A ⑤
V _{GS(th)}	Gate Threshold Voltage	2.6	3.0	3.9	V	$V_{DS} = V_{GS}, I_{D} = 100 \mu A$
gfs	Forward Transconductance	119			S	V _{DS} = 10V, I _D = 50A
R _G	Internal Gate Resistance		1.5		Ω	
	Dursin to Courses Lookana Coursent			1.0		$V_{DS} = 40V, V_{GS} = 0V$
IDSS	Drain-to-Source Leakage Current			150	μA	V _{DS} = 40V, V _{GS} = 0V, T _J = 125°C
I _{GSS}	Gate-to-Source Forward Leakage			100	n A	V _{GS} = 20V
	Gate-to-Source Reverse Leakage			-100	nA	V _{GS} = -20V

Dynamic Electrical Characteristics @ T_J = 25°C (unless otherwise specified)

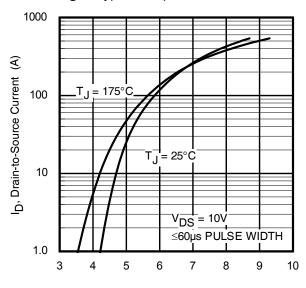
Symbol	Parameter	Min.	Тур.	Max.	Units	Conditions		
Q_g	Total Gate Charge		65	98		I _D = 50A		
Q_gs	Gate-to-Source Charge		16			V _{DS} = 20V		
Q_{gd}	Gate-to-Drain ("Miller") Charge		23 —		nC	V _{GS} = 10V ⑤		
Q _{sync}	Total Gate Charge Sync. (Q _g - Q _{gd})		42			$I_{D} = 50A, V_{DS} = 0V, V_{GS} = 10V$		
t _{d(on)}	Turn-On Delay Time		11			V _{DD} = 20V		
t _r	Rise Time		37			I _D = 30A		
t _{d(off)}	Turn-Off Delay Time		33		ns	R _G = 2.7Ω		
t _f	Fall Time		26			V _{GS} = 10V		
C _{iss}	Input Capacitance		3174			V _{GS} = 0V		
C _{oss}	Output Capacitance		479			V _{DS} = 25V		
C _{rss}	Reverse Transfer Capacitance		332		pF	<i>f</i> = 1.0 MHz		
Coss eff. (ER)	Effective Output Capacitance (Energy Related)		637			$V_{GS} = 0V, V_{DS} = 0V \text{ to } 32V \bigcirc$		
C _{oss} eff. (TR)	Effective Output Capacitance (Time Related)		656			$V_{GS} = 0V, V_{DS} = 0V \text{ to } 32V \text{ (6)}$		
Diode Charact	Diode Characteristics							

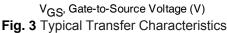
Symbol	Parameter	Min.	Тур.	Max.	Units	Conditions
1	Continuous Source Current			122①	А	MOSFET symbol
IS	(Body Diode)				A	showing the
1	Pulsed Source Current			520	^	integral reverse 🛛 斗 🗍
I _{SM}	(Body Diode) ②				A	p-n junction diode.
V _{SD}	Diode Forward Voltage		0.9	1.3	V	$T_J = 25^{\circ}C, I_S = 50A, V_{GS} = 0V$ (5)
dv/dt	Peak Diode Recovery ④		2.5		V/ns	T _J = 175°C, I _S = 50A, V _{DS} = 40V
4			16		20	T _J = 25°C
Lrr	Reverse Recovery Time		18		ns	$T_{\rm J} = 125^{\circ}C$ $V_{\rm R} = 34V$,
Q _{rr}	Roverse Recovery Charge		5.0		nC	$T_{\rm J} = 25^{\circ}C$ $I_{\rm F} = 50A$,
Qn	Reverse Recovery Charge		6.9			T _J = 125°C di/dt = 100A/µs⑤
I _{RRM}	Reverse Recovery Current		0.50		А	$T_J = 25^{\circ}C$

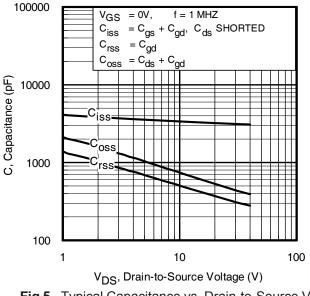


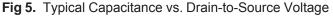
1000 VGS 15V 10V TOP 8.0V 7.0V l_D, Drain-to-Source Current (A) 100 6.0V 5.5V 5.0V воттом 4.5V 10 1 ≤60µs PULSE WIDT⊦ = 25°C Ti 0.1 10 0.1 1 100 V_{DS}, Drain-to-Source Voltage (V)

Fig. 1 Typical Output Characteristics









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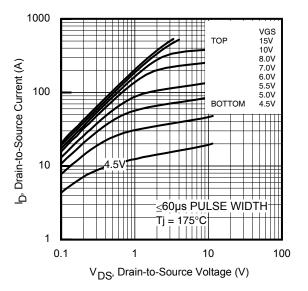


Fig. 2 Typical Output Characteristics

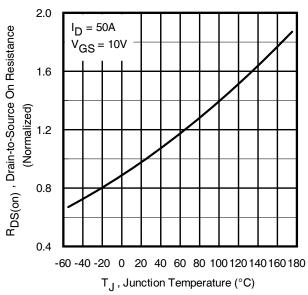
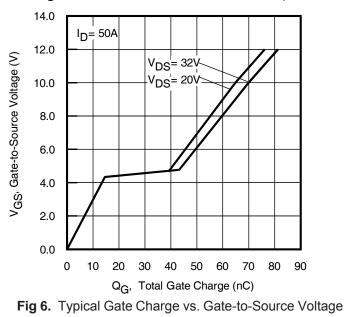


Fig. 4 Normalized On-Resistance vs. Temperature





I_{SD}, Reverse Drain Current (A)

I_D, Drain Current (A)

25

50

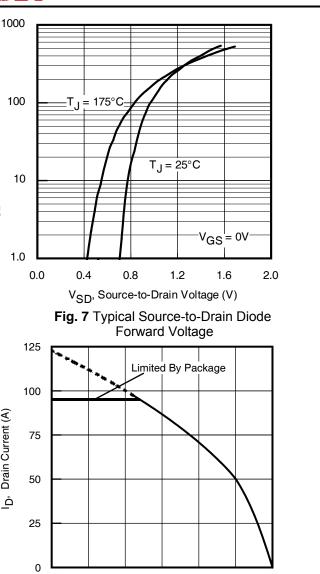


Fig 9. Maximum Drain Current vs. Case Temperature

100

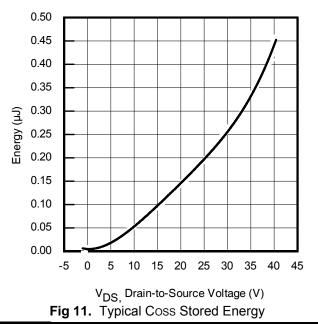
 ${\sf T}_{C}$, Case Temperature (°C)

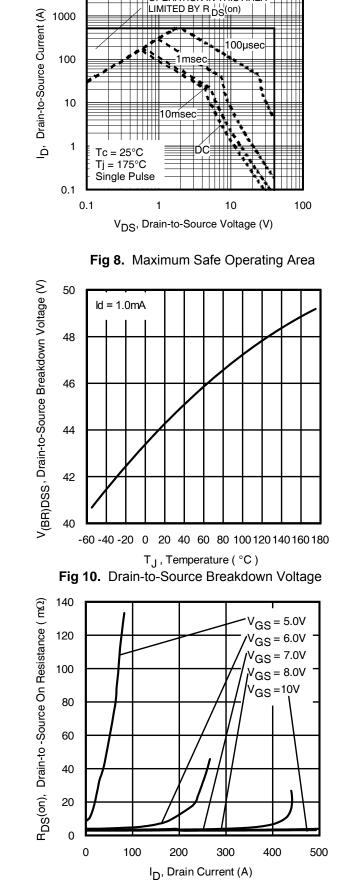
125

150

175

75





10000

Fig 12. Typical On-Resistance vs. Drain Current

OPERATION IN THIS ARE



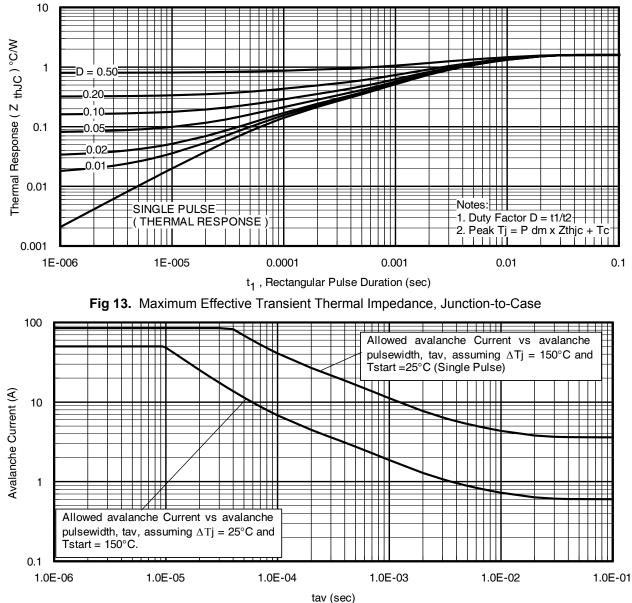


Fig 14. Typical Avalanche Current vs.Pulsewidth

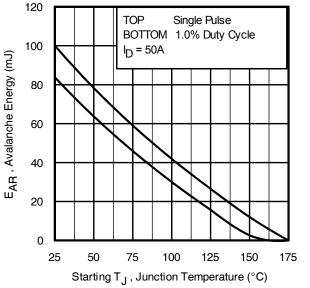


Fig 15. Maximum Avalanche Energy vs. Temperature

Notes on Repetitive Avalanche Curves , Figures 13, 14: (For further info, see AN-1005 at www.irf.com)

- 1. Avalanche failures assumption:
- Purely a thermal phenomenon and failure occurs at a temperature far in excess of T_{jmax}. This is validated for every part type.
- 2. Safe operation in Avalanche is allowed as long as T_{jmax} is not exceeded.
- 3. Equation below based on circuit and waveforms shown in Figures 16a, 16b.
- 4. PD (ave) = Average power dissipation per single avalanche pulse.
- 5. BV = Rated breakdown voltage (1.3 factor accounts for voltage increase during avalanche).
- 6. Iav = Allowable avalanche current.
- 7. ΔT = Allowable rise in junction temperature, not to exceed T_{jmax} (assumed as 25°C in Figure 14, 15).

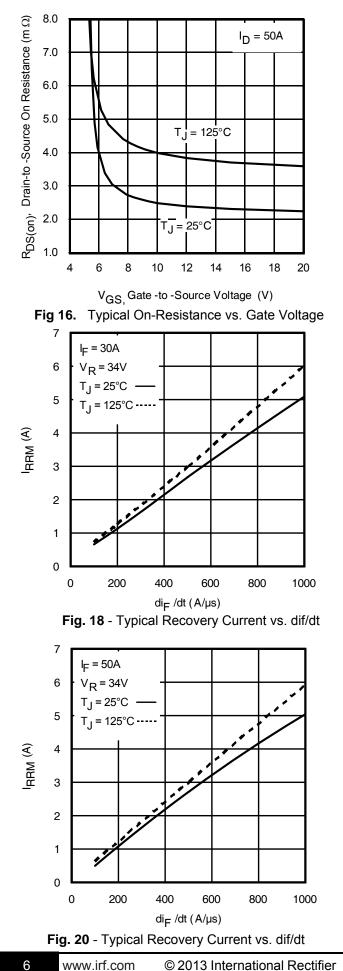
tav = Average time in avalanche.

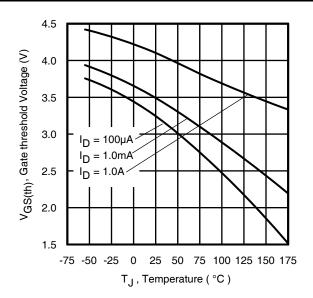
- D = Duty cycle in avalanche = tav ·f
- ZthJC(D, tav) = Transient thermal resistance, see Figures 13)

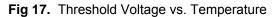
$$\begin{split} \textbf{P}_{D (ave)} &= 1/2 \text{ (} 1.3 \text{ -BV-} \textbf{I}_{av} \text{)} = \Delta T \text{ / } \textbf{Z}_{thJC} \\ \textbf{I}_{av} &= 2\Delta T \text{ / } [1.3 \text{ -BV-} \textbf{Z}_{th}] \\ \textbf{E}_{AS (AR)} &= \textbf{P}_{D (ave)} \text{ \cdot } \textbf{t}_{av} \end{split}$$



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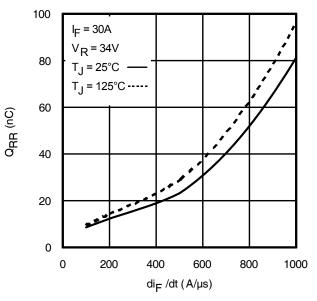
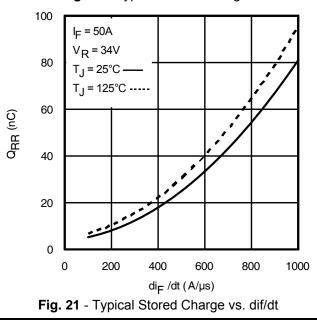
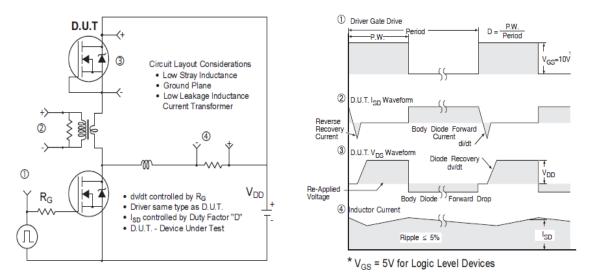
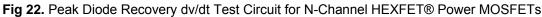


Fig. 19 - Typical Stored Charge vs. dif/dt



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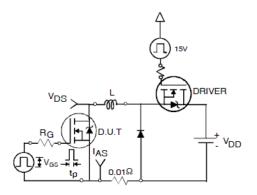


Fig 22a. Unclamped Inductive Test Circuit

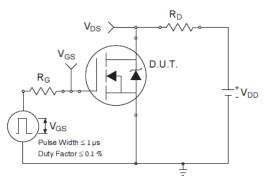


Fig 23a. Switching Time Test Circuit

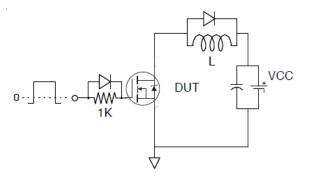


Fig 24a. Gate Charge Test Circuit

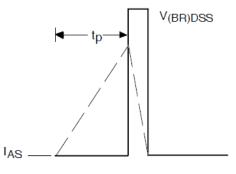


Fig 22b. Unclamped Inductive Waveforms

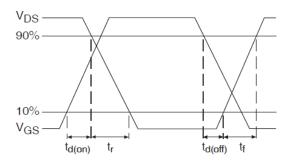


Fig 23b. Switching Time Waveforms

ld

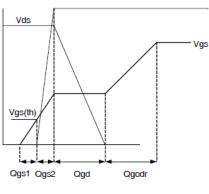
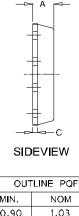
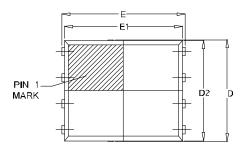


Fig 24b. Gate Charge Waveform

7

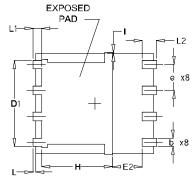
PQFN 5x6 Outline "E" Package Details





TOP VIEW

	-		
STNBOL	OUT	LINE PQFI	N 5X6E
STA	MIN.	NOM	MAX.
A	0.90	1.03	1.17
b	0.33	0.41	0.48
С	0.20	0.25	0.35
D	4.80	4.98	5.15
D1	3.91	4.11	4.31
D2	4.80	4.90	5.00
E	5.90	6.02	6.15
E1	5.65	5.75	5.85
E2	1.10	_	_
e		1.27 BSC)
L	0.05	0.15	0.25
L1	0.38	0.44	0.50
L2	0.51	0.68	0.86
Н	3.32	3.45	3.58
			0.18

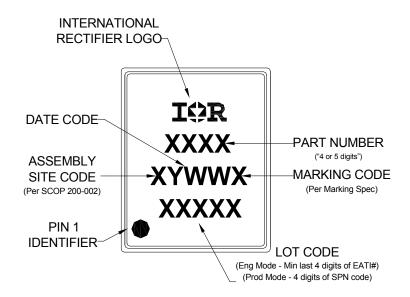


BOTTOM VIEW

For more information on board mounting, including footprint and stencil recommendation, please refer to application note AN-1136: http://www.irf.com/technical-info/appnotes/an-1136.pdf

For more information on package inspection techniques, please refer to application note AN-1154: http://www.irf.com/technical-info/appnotes/an-1154.pdf

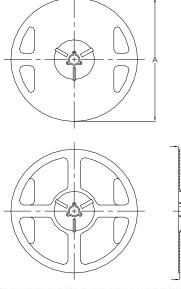
PQFN 5x6 Outline "E" Part Marking

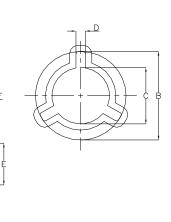


Note: For the most current drawing please refer to IR website at http://www.irf.com/package/

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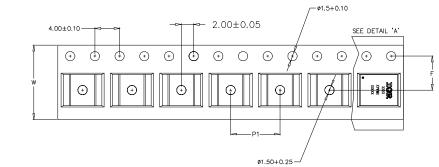
PQFN 5x6 Outline "E" Tape and Reel

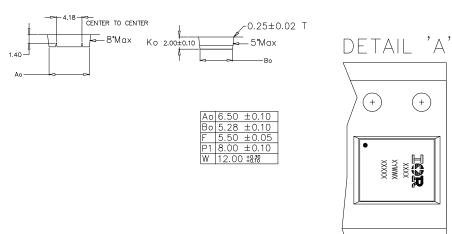




NOTE: Controlling dimensions in mm Std reel quantity is 4000 parts.

			RE	EL DIMEN	ISIONS			
S	TANDAR	D OPTIO	N (QTY 40	00)	TF	2 OPTIO	N (QTY 40)0)
	M	ETRIC	IMP	ERIAL	M	ETRIC	IMF	PERIAL
CODE	MIN	MAX	MIN	MAX	MIN	MAX	MIN	MAX
A	329.5	330.5	12.972	13.011	177.5	178.5	6.988	7.028
В	20.9	21.5	0.823	0.846	20.9	21.5	0.823	0.846
С	12.8	13.5	0.504	0.532	13.2	13.8	0.520	0.543
D	1.7	2.3	0.067	0.091	1.9	2.3	0.075	0.091
Е	97	99	3.819	3.898	65	66	2.350	2.598
F	Ref	17.4	а. М		Ref	12		22
G	13	14.5	0.512	0.571	13	14.5	0.512	0.571





Qualification Information[†]

		Automotive (per AEC-Q101)				
		Comments: This part number(s) passed Automotive qualification. IR's Industrial and Consumer qualification level is granted by extension of the higher Automotive level.				
Moisture Sensitivity Level		PQFN 5mm x 6mm	MSL1			
	Machine Model	Class M3 (+/- 400V) ^{††}				
		AEC-Q101-002				
	Human Body Model	Class H1C (+/- 2000V) ^{††}				
ESD		AEC-Q101-001				
	Charged Device Model	Class C5 (+/- 1000V) ^{††}				
		AEC-Q101-005				
RoHS Compliant		Yes				

† Qualification standards can be found at International Rectifier's web site: http://www.irf.com/

†† Highest passing voltage.

Notes:

- Calculated continuous current based on maximum allowable junction temperature. Current is limited to 95A by source bond technology. Note that current limitations arising from heating of the device leads may occur with some lead mounting arrangements. (Refer to AN-1140)
- ② Repetitive rating; pulse width limited by max. junction temperature.
- ③ Limited by T_{Jmax} , starting TJ = 25°C, L = 0.080mH R_G = 50 Ω , I_{AS} = 50A, V_{GS} =10V.
- $\label{eq:ISD} \ensuremath{\textcircled{\sc star}}\ I_{SD} \leq 50A, \ di/dt \leq 817A/\mu s, \ V_{DD} \leq V_{(BR)DSS}, \ T_J \leq 150^\circ C.$

- $\label{eq:pulse width length} $$ S Pulse width \le 400 \mu s; duty cycle \le 2\%.$
- @ Coss eff. (TR) is a fixed capacitance that gives the same charging time as Coss while V_{DS} is rising from 0 to 80% $V_{DSS}.$
- $\odot~$ Coss eff. (ER) is a fixed capacitance that gives the same energy as Coss while V_{DS} is rising from 0 to 80% $V_{DSS}.$
- When mounted on 1 inch square 2 oz copper pad on 1.5 x 1.5 in. board of FR-4 material.
- In this value determined from sample failure population, starting T_J = 25°C, L= 0.080mH, R_G = 50Ω, I_{AS} = 50A, V_{GS} = 10V.

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IR products are neither designed nor intended for us e in automotive applications or environments unless the specific IR products are designated by IR as compliant with ISO/TS 16949 requirements and bear a part number including the designation "AU". Buyers acknowledge and agree that, if they use any non-designated products in automotive applications, IR will not be responsible for any failure to meet such requirements.

For technical support, please contact IR's Technical Assistance Center

http://www.irf.com/technical-info/

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Tel: (310) 252-7105